2N2907A

Switching Transistor

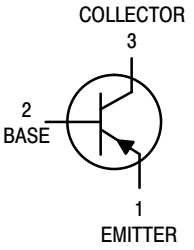
PNP Silicon Epitaxial

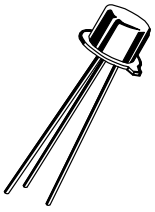
ON Semiconductor®

http://onsemi.com

Features

- MIL−PRF−19500/291 Qualified
- Available as JAN, JANTX, and JANTXV
- Hermetically Sealed Commercial Product with Option for Military Temperature Range Screening





TO−18
CASE 206AA
STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector − Emitter Voltage	V_{CEO}	−60	Vdc
Collector − Base Voltage	V_{CBO}	−60	Vdc
Emitter − Base Voltage	V_{EBO}	−5.0	Vdc
Collector Current − Continuous	I_C	−600	mAdc
Total Device Dissipation @ T_A = 25°C Derate above 25°C	P_T	625 5.0	mW mW/°C
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_T	1.5 12	W mW/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	−65 to +200	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction−to−Ambient	$R_{\theta JA}$	325	°C/W
Thermal Resistance, Junction−to−Case	$R_{\theta JC}$	150	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ORDERING INFORMATION

Device	Package	Shipping
JAN2N2907A	TO−18	Bulk
JANTX2N2907A		
JANTXV2N2907A		

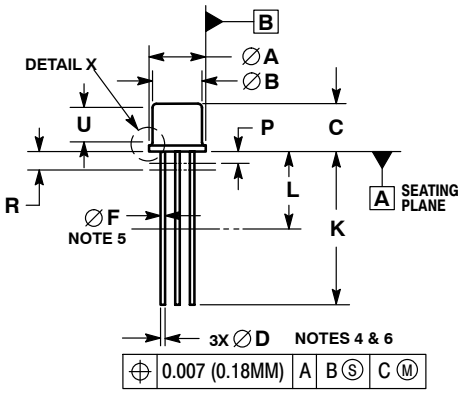
ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

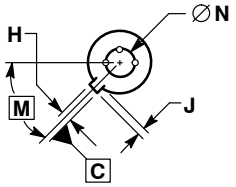
Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage (Note 1) (I_C = –10 mAdc, I_B = 0)		$V_{(BR)CEO}$	–60	–	Vdc
Collector – Base Breakdown Voltage (I_C = –10 μAdc, I_E = 0)		$V_{(BR)CBO}$	–60	–	Vdc
Emitter – Base Breakdown Voltage (I_E = –10 μAdc, I_C = 0)		$V_{(BR)EBO}$	–5.0	–	Vdc
Collector Cutoff Current (V_{CE} = –30 Vdc, $V_{EB(off)}$ = –0.5 Vdc)		I_{CEX}	–	–50	nAdc
Collector Cutoff Current (V_{CB} = –50 Vdc, I_E = 0) (V_{CB} = –50 Vdc, I_E = 0, T_A = 150°C)		I_{CBO}	 – –	 –0.01 –10	μAdc
Base Current (V_{CE} = –30 Vdc, $V_{EB(off)}$ = –0.5 Vdc)		I_B	–	–50	nAdc
ON CHARACTERISTICS					
DC Current Gain (I_C = –0.1 mAdc, V_{CE} = –10 Vdc) (I_C = –1.0 mAdc, V_{CE} = –10 Vdc) (I_C = –10 mAdc, V_{CE} = –10 Vdc) (I_C = –150 mAdc, V_{CE} = –10 Vdc) (Note 1) (I_C = –500 mAdc, V_{CE} = –10 Vdc) (Note 1)		h_{FE}	 75 100 100 100 50	 – – – 300 –	–
Collector – Emitter Saturation Voltage (Note 1) (I_C = –150 mAdc, I_B = –15 mAdc) (I_C = –500 mAdc, I_B = –50 mAdc)		$V_{CE(sat)}$	 – –	 –0.4 –1.6	Vdc
Base – Emitter Saturation Voltage (Note 1) (I_C = –150 mAdc, I_B = –15 mAdc) (I_C = –500 mAdc, I_B = –50 mAdc)		$V_{BE(sat)}$	 –0.6 –	 –1.3 –2.6	Vdc
SMALL–SIGNAL CHARACTERISTICS					
Current – Gain – Bandwidth Product (Notes 1 and 2), (I_C = –50 mAdc, V_{CE} = –20 Vdc, f = 100 MHz)		f_T	200	–	MHz
$\|h_{fe}\|$, (I_C = –20 mAdc, V_{CE} = –20 Vdc, f = 100 MHz)			2.0	–	–
Output Capacitance (V_{CB} = –10 Vdc, I_E = 0, 100 kHz ≤ f ≤ 1.0 MHz)		C_{obo}	–	8.0	pF
Input Capacitance (V_{EB} = –2.0 Vdc, I_C = 0, f = 1.0 MHz)		C_{ibo}	–	30	pF
SWITCHING CHARACTERISTICS					
Turn–On Time	(V_{CC} = –30 Vdc, I_C = –150 mAdc, I_{B1} = –15 mAdc) (Figures NO TAG and NO TAG)	t_{on}	–	45	ns
Delay Time		t_d	–	10	ns
Rise Time		t_r	–	40	ns
Turn–Off Time	(V_{CC} = –6.0 Vdc, I_C = –150 mAdc, I_{B1} = I_{B2} = 15 mAdc) (Figure NO TAG)	t_{off}	–	100	ns
Storage Time		t_s	–	80	ns
Fall Time		t_f	–	30	ns

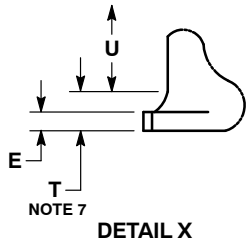
1. Pulse Test: See section 4 of MIL–STD–750.
2. f_T is defined as the frequency at which $|h_{fe}|$ extrapolates to unity.

PACKAGE DIMENSIONS

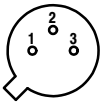
TO−18 3
CASE 206AA−01
ISSUE O







DETAIL X



LEAD IDENTIFICATION DETAIL

NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. DIMENSION J MEASURED FROM DIAMETER A TO EDGE.
4. LEAD TRUE POSITION TO BE DETERMINED AT THE GUAGE PLANE DEFINED BY DIMENSION R.
5. DIMENSION F APPLIES BETWEEN DIMENSION P AND L.
6. DIMENSION D APPLIES BETWEEN DIMENSION L AND K.
7. BODY CONTOUR OPTIONAL WITHIN ZONE DEFINED BY DIMENSIONS A, B, AND T.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	5.31	5.84	0.209	0.230
B	4.52	4.95	0.178	0.195
C	4.32	5.33	0.170	0.210
D	0.41	0.53	0.016	0.021
E	---	0.76	---	0.030
F	0.41	0.48	0.016	0.019
H	0.91	1.17	0.036	0.046
J	0.71	1.22	0.028	0.048
K	12.70	19.05	0.500	0.750
L	6.35	---	0.250	---
M	45 ° BSC		45 ° BSC	
N	2.54 BSC		0.100 BSC	
P	---	1.27	---	0.050
R	1.37 BSC		0.054 BSC	
T	---	0.76	---	0.030
U	2.54	---	0.100	---

STYLE 1:
PIN 1. EMITTER
2. BASE
3. COLLECTOR

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
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